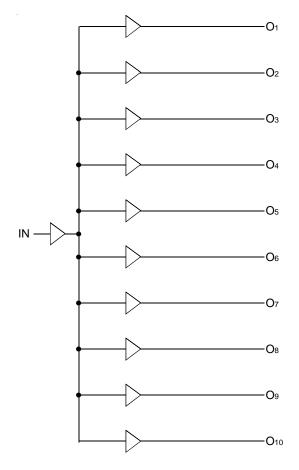


### 3.3V CMOS 1-TO-10 CLOCK DRIVER

#### **FEATURES:**

- Advanced CMOS Technology
- Guaranteed low skew < 100ps (max.)
- Very low duty cycle distortion< 250ps (max.)
- High speed propagation delay< 2ns (max.)</li>
- · Very low CMOS power levels
- TTL compatible inputs and outputs
- 1:10 fanout
- Maximum output rise and fall time < 1ns (max.)
- Low input capacitance: 3pF typical
- VCC = 3.3V ± 0.3V
- · Inputs can be driven from 3.3V or 5V components
- Operating frequency up to 166MHz
- Available in SSOP, QSOP, and TSSOP packages

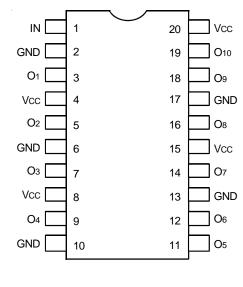
# **FUNCTIONAL BLOCK DIAGRAM**



### **PIN CONFIGURATION**

applications are clock and signal distribution.

**DESCRIPTION:** 



The FCT3807 is a 3.3V clock driver built using advanced CMOS technol-

ogy. This low skew clock driver offers 1:10 fanout. The large fanout from a single

input reduces loading on the preceding driver and provides an efficient clock

distribution network. Multiple power and grounds reduce noise. Typical

SSOP/ QSOP/ TSSOP TOP VIEW

The IDT logo is a registered trademark of Integrated Device Technology, Inc.

#### **JULY 2006**

#### **INDUSTRIAL TEMPERATURE RANGE**

#### ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

Symbol	Description	Max	Unit
Vcc	Input Power Supply Voltage	-0.5 to +4.6	V
Vi	InputVoltage	–0.5 to +5.5	V
Vo	OutputVoltage	-0.5 to Vcc+0.5	V
TJ	Junction Temperature	150	°C
Tstg	StorageTemperature	-65 to +165	°C

NOTE:

 Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

### **CAPACITANCE** (TA = +25°C, f = 1.0MHz)

Symbol	Parameter <sup>(1)</sup>	Conditions	Тур.	Max.	Unit
Cin	Input Capacitance	VIN = 0V	3	4	рF
Соит	Output Capacitance	Vout = 0V	—	6	pF

NOTE:

1. This parameter is measured at characterization but not tested.

#### **PIN DESCRIPTION**

Pin Names	Description
IN	Input
Ох	Outputs

#### **POWER SUPPLY CHARACTERISTICS**

Symbol	Parameter	TestCor	nditions <sup>(1)</sup>	Min.	Тур. <sup>(2)</sup>	Max.	Unit
lcco	Quiescent Power Supply Current	Vcc = Max.	VIN = GND or VCC	-	0.1	30	μA
Δlcc	Power Supply Current per Input HIGH	Vcc = Max.	VIN = VCC - 0.6V	-	45	300	μA
ICCD	Dynamic Power Supply Current	Vcc = Max.	VIN = VCC	-	80	120	µA/MHz
	per Output <sup>(3)</sup>	CL = 15pF	VIN = GND				
		All Outputs Toggling					
Ic	Total Power Supply Current <sup>(4)</sup>	Vcc = Max.	VIN = VCC		125	150	
		CL = 15pF	VIN = GND				
		All Outputs Toggling	VIN = VCC -0.6V		125	150	
		fi = 133MHz	VIN = GND				mA
		Vcc = Max.	VIN = VCC	_	155	195	
		CL = 15pF	VIN = GND				
		All Outputs Toggling	VIN = VCC -0.6V	-	160	195	1
		fi = 166MHz	Vin = GND				

NOTES:

1. For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.

2. Typical values are at Vcc = 3.3V, +25°C ambient.

3. This parameter is not directly testable, but is derived for use in Total Power Supply calculations.

4. IC = IQUIESCENT + INPUTS + IDYNAMIC

 $IC = ICC + \Delta ICC DHNT + ICCD$  (fi)

Icc = Quiescent Current

- $\Delta Icc$  = Power Supply Current for a TTL High Input (VIN = Vcc -0.6V)
- $\mathsf{D}\mathsf{H}$  = Duty Cycle for TTL Inputs High

NT = Number of TTL Inputs at DH

ICCD = Dynamic Current Caused by an Input Transition Pair (HLH or LHL)

fi = Input Frequency

# DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified Industrial: TA =  $-40^{\circ}$ C to  $+85^{\circ}$ C, Vcc = 3.3V  $\pm 0.3$ V

Symbol	Parameter	Test Conditions <sup>(1)</sup>		Min.	Тур. <sup>(2)</sup>	Max.	Unit
Vih	Input HIGH Level			2	_	5.5	V
Vil	Input LOW Level			-0.5	_	0.8	V
Ін	Input HIGH Current	Vcc = Max.	VI = 5.5V	-	_	±1	μA
lil	Input LOW Current	Vcc = Max.	VI = GND	-	_	±1	1
Vik	Clamp Diode Voltage	VCC = Min., IIN = -18mA	Vcc = Min., IIN = -18mA		-0.7	-1.2	V
Iodh	Output HIGH Current	VCC = 3.3V, VIN = VIH O	$VCC = 3.3V$ , $VIN = VIH \text{ or } VIL$ , $VO = 1.5V^{(3,4)}$		-75	-180	mA
IODL	Output LOW Current	VCC = 3.3V, VIN = VIH O	VCC = $3.3V$ , VIN = VIH or VIL, VO = $1.5V^{(3,4)}$		92	200	mA
los	Short Circuit Current	Vcc = Max., Vo = GND	$VCC = Max., VO = GND^{(3,4)}$		-135	-240	mA
Vон	Output HIGH Voltage	Vcc = Min.	Iон = –12mA	2.4 <sup>(5)</sup>	3	_	V
		$VIN = VIH \text{ or } VIL$ IOH = -100 $\mu$ A		Vcc-0.2	_	_	
Vol	Output LOW Voltage	Vcc = Min.	Vcc = Min. IoL = 12mA		0.3	0.5	V
		VIN = VIH or VIL	IOL = 100µA	_	_	0.2	

NOTES:

1. For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.

2. Typical values are at Vcc = 3.3, 25°C ambient.

3. This parameter is guaranteed but not tested.

4. Not more than one output should be shorted at one time. Duration of the test should not exceed one second.

5. VOH = Vcc - 0.6V at rated current.

**INDUSTRIAL TEMPERATURE RANGE** 

## SWITCHING CHARACTERISTICS OVER OPERATING RANGE - 3807D (3,4)

Symbol	Parameter	Conditions <sup>(1)</sup>	Min. <sup>(2)</sup>	Max.	Unit
<b>t</b> PLH	Propagation Delay	CL = 15pF	1	2.5	ns
<b>t</b> PHL		$f \le 133 MHz$			
tR.	Output Rise Time (0.8V to 2V)		—	1	ns
tF	Output Fall Time (2V to 0.8V)		—	1	ns
tsk(0)	Same device output pin-to-pin skew <sup>(5)</sup>		—	250	ps
tsk(P)	Pulse skew <sup>(6)</sup>		—	250	ps
tsk(PP)	Part to part skew <sup>(7)</sup>		—	550	ps
fMAX	Input Frequency		—	133	MHz

### SWITCHING CHARACTERISTICS OVER OPERATING RANGE - 3807E (3,4)

Symbol	Parameter	Conditions <sup>(1,8)</sup>	Min. <sup>(2)</sup>	Max.	Unit
<b>t</b> PLH	Propagation Delay	CL = 15pF	0.5	2	ns
<b>t</b> PHL		$f \le 166MHz$			
ĪR	Output Rise Time (0.8V to 2V)		—	1	ns
tF	Output Fall Time (2V to 0.8V)		_	1	ns
tsk(0)	Same device output pin-to-pin skew <sup>(5)</sup>		—	100	ps
tsk(P)	Pulse skew <sup>(6)</sup>		—	250	ps
tsk(PP)	Part to part skew <sup>(7)</sup>		_	550	ps
fMAX	Input Frequency		_	166	MHz

NOTES:

1. See test circuits and waveforms.

2. Minimum limits are guaranteed but not tested on Propagation Delays.

3. tPLH, tPHL, tsk(P), and tsk(o) are production tested. All other parameters guaranteed but not production tested.
 4. Propagation delay range indicated by Min. and Max. limit is due to Vcc, operating temperature and process parameters. These propagation delay limits do not imply skew.

5. Skew measured between all outputs under identical transitions and load conditions.

6. Skew measured is difference between propagation delay times tPHL and tPLH of same output under identical load conditions.

7. Part to part skew for all outputs given identical transitions and load conditions at identical Vcc levels and temperature.

8. Airflow of 1m/s is recommended for frequencies above 133MHz.

### **TEST CIRCUITS**

#### **TEST CONDITIONS**

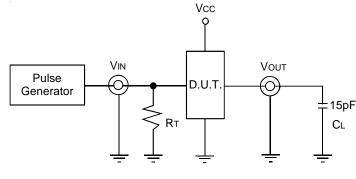
Symbol	$Vcc = 3.3V \pm 0.3V$	Unit
CL	15	pF
Rt	ZOUT of pulse generator	Ω
tr / tr	1 (0V to 3V or 3V to 0V)	ns

#### **DEFINITIONS:**

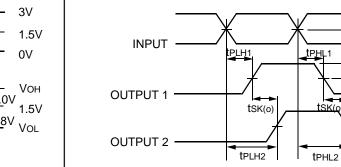
CL = Load capacitance: includes jig and probe capacitance.

RT = Termination resistance: should be equal to ZOUT of the Pulse Generator.

tR / tF = Rise/Fall time of the input stimulus from the Pulse Generator.







tSK(o) = |tPLH2 - tPLH1| or |tPHL2 - tPHL1|

- 3V - 1.5V

- 0V

νон

1.5V

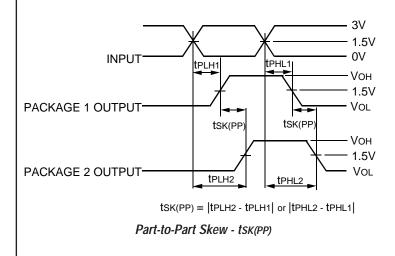
- Vol

Voн

1.5V

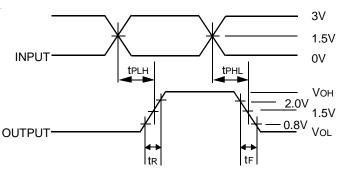
- Vol

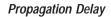
Output Skew - tsk(0)

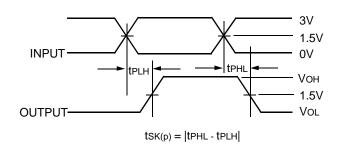




### **TEST WAVEFORMS**

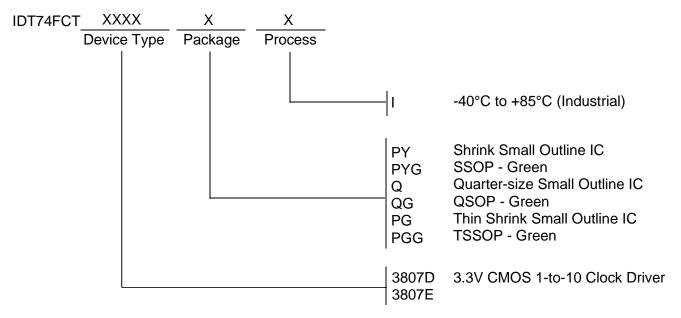








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